

ТАВ

G(1)

O

DPAK

Figure 1: Internal schematic diagram

D(2, TAB) O

S(3) Ö

STD105N10F7AG

Automotive-grade N-channel 100 V, 6.8 mΩ typ., 80 A, STripFET™ F7 Power MOSFET in a DPAK package

Datasheet - production data



Order code	VDS	RDS(on) max.	ID	Ртот
STD105N10F7AG	100 V	8 mΩ	80 A	120 W

- Designed for automotive applications and AEC-Q101 qualified
- Among the lowest R_{DS(on)} on the market
- Excellent FoM (figure of merit)
- Low C_{rss}/C_{iss} ratio for EMI immunity
- High avalanche ruggedness

Applications

• Switching applications

Description

This N-channel Power MOSFET utilizes STripFET[™] F7 technology with an enhanced trench gate structure that results in very low onstate resistance, while also reducing internal capacitance and gate charge for faster and more efficient switching.

Table 1: Device summary

AM01475v1_Tab

Order code	Marking	Package	Packing
STD105N10F7AG	105N10F7	DPAK	Tape and reel

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This is information on a product in full production.

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1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit	
Vds	Drain-source voltage	100	V	
V _{GS}	Gate-source voltage	± 20	V	
lD	Drain current (continuous) at T _C = 25 °C	80	А	
lo	Drain current (continuous) at T _C = 100 °C	62	А	
IDM ⁽¹⁾	Drain current (pulsed)	320	А	
Ртот	P_{TOT} Total dissipation at $T_C = 25 \text{ °C}$		W	
T _{stg}	T _{stg} Storage temperature range		°C	
TJ	Operation junction temperature range	55 to 175 °C		

Notes:

 $^{(1)}\mbox{Pulse}$ width limited by safe operating area.

Table 3: Thermal data					
Symbol	Parameter	Value	Unit		
R _{thj-case}	Thermal resistance junction-case	1.25	°C/W		
Rthj-pcb ⁽¹⁾	Thermal resistance junction-pcb	50	°C/vv		

Notes:

⁽¹⁾When mounted on FR-4 board of 1 inch², 2oz Cu.

Table	4:	Avalanche	characteristics
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Symbol	Parameter	Value	Unit
Eas	Single pulse avalanche energy T_J = 25 °C, L = 3.5 mH, I_{AS} = 15 A, V_{DD} = 50 V, V_{GS} = 10 V	400	mJ



2 Electrical characteristics

(T_{CASE} = 25 °C unless otherwise specified)

Table 5: On/Off states							
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit	
V _{(BR)DSS}	Drain-source breakdown voltage (V _{GS} = 0)	I _D = 250 μA	100			V	
1	Zero gate voltage	V _{DS} = 100 V			1	μA	
IDSS	drain current (V _{GS} = 0)	$V_{DS} = 100 \text{ V}, \text{ T}_{C} = 125 \text{ °C} (1)$			100	μΑ	
I _{GSS} Gate body leakage current (V _{DS} = 0)		V _{GS} = ± 20 V			± 100	nA	
V _{GS(th)}	Gate threshold voltage	V_{DS} = V_{GS} , I_D = 250 μ A	2.5		4.5	V	
R _{DS(on)}	Static drain-source on-resistance	V _{GS} = 10 V, I _D = 40 A		6.8	8	mΩ	

Notes:

⁽¹⁾Defined by design, not subject to production test.

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	4369	-	pF
Coss	Output capacitance	$V_{DS} = 50 V, f = 1 MHz,$	-	823	-	pF
Crss	Reverse transfer capacitance	V _{GS} = 0 V		36	-	pF
Qg	Total gate charge	$V_{DD} = 50 \text{ V}, \text{ I}_{D} = 80 \text{ A},$	-	61	-	nC
Qgs	Gate-source charge	V _{GS} = 10 V	-	26	-	nC
Q _{gd}	Gate-drain charge	(see Figure 14: "Test circuit for gate charge behavior")	-	13	-	nC

Table 6: Dynamic

Table 7: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	$V_{DD} = 50 \text{ V}, I_D = 40 \text{ A},$	-	27	-	ns
tr	Rise time	$R_G = 4.7 \Omega$, $V_{GS} = 10 V$	-	40	-	ns
t _{d(off)}	Turn-off delay time	(see Figure 13: "Test circuit for resistive load switching times"	-	46	-	ns
t _f	Fall time	and Figure 18: "Switching time waveform")	-	15	-	ns



Electrical characteristics

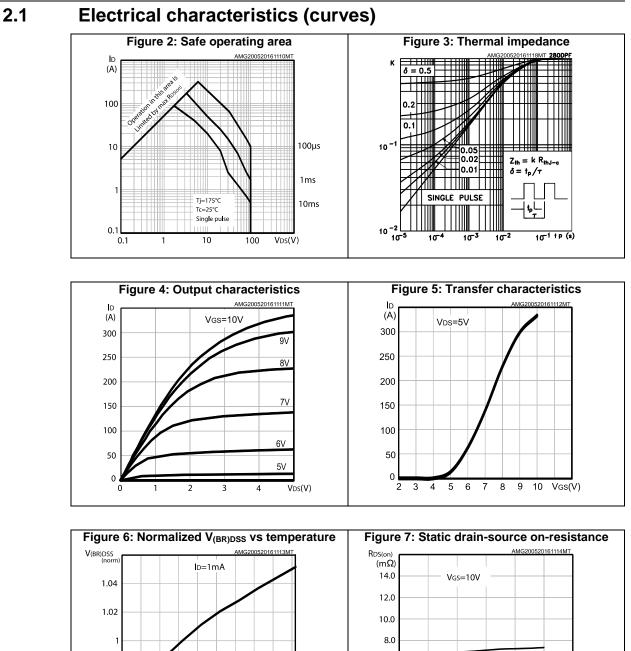
Table 8: Source-drain diode							
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit	
Isd	Source-drain current		-		80	Α	
ISDM ⁽¹⁾	Source-drain current (pulsed)				320	А	
V _{SD} ⁽²⁾	Forward on voltage I _{SD} = 80 A, V _{GS} = 0 V		-		1.2	V	
trr	Reverse recovery time		-	77		ns	
Qrr	Reverse recovery charge	I _{SD} = 80 A, di/dt = 100 A/µs V _{DD} = 80 V, T _j = 150 °C	-	146		nC	
IRRM	Reverse recovery current	100 - 00 1, 1j - 100 0	-	4		А	

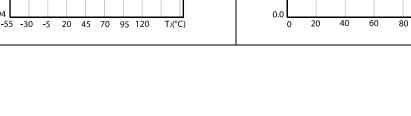
Notes:

 $\ensuremath{^{(1)}}\ensuremath{\mathsf{Pulse}}$ width limited by safe operating area.

 $^{(2)}\text{Pulsed:}$ pulse duration = 300 µs, duty cycle 1.5 %.







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4.0

2.0

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100

ID(A)

0.98

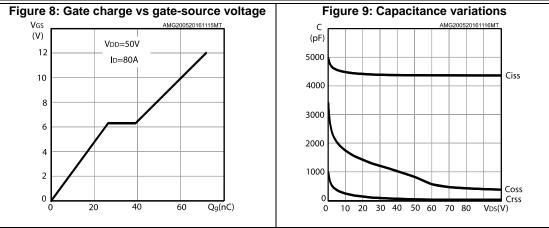
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Electrical characteristics



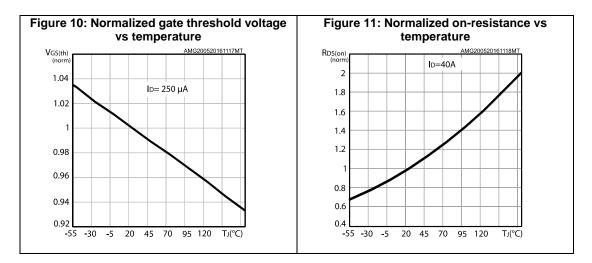
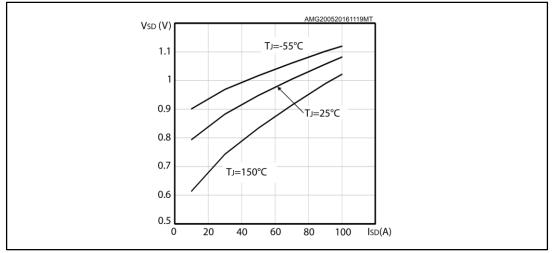
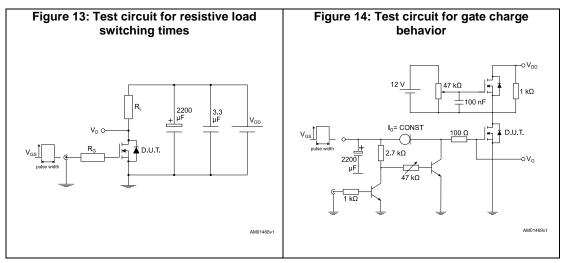


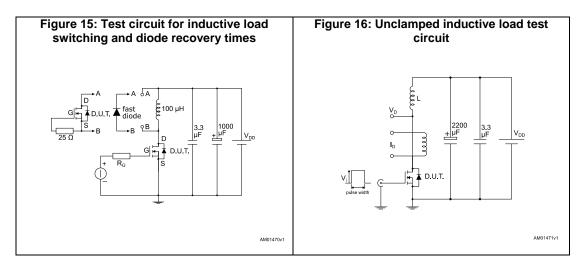
Figure 12: Source-drain diode forward characteristics

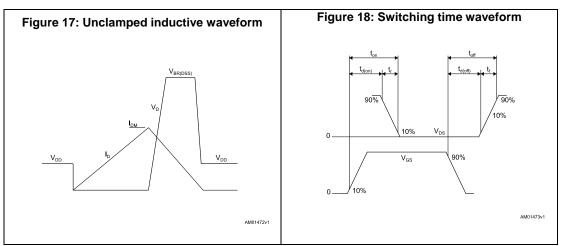


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3 Test circuits







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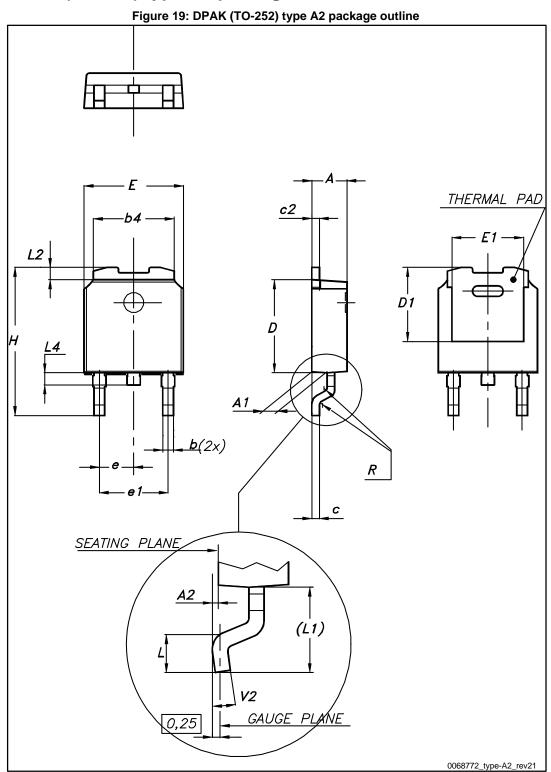
4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.



Package information





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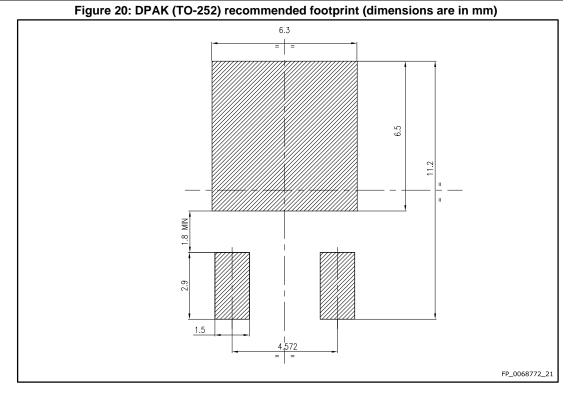
Package information

10F7AG Package informa				
Γ	Table 9: DPAK (TO-252) type A2 mechanical da	ita	
Dim.		mm		
	Min.	Тур.	Max.	
А	2.20		2.40	
A1	0.90		1.10	
A2	0.03		0.23	
b	0.64		0.90	
b4	5.20		5.40	
С	0.45		0.60	
c2	0.48		0.60	
D	6.00		6.20	
D1	4.95	5.10	5.25	
E	6.40		6.60	
E1	5.10	5.20	5.30	
е	2.16	2.28	2.40	
e1	4.40		4.60	
Н	9.35		10.10	
L	1.00		1.50	
L1	2.60	2.80	3.00	
L2	0.65	0.80	0.95	
L4	0.60		1.00	
R		0.20		
V2	0°		8°	



Package information

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5 Revision history

Table 10: Document revision history

Date	Revision	Changes
23-Oct-2014	1	First release.
30-Oct-2014	2	Document status promoted from preliminary to production data.
20-May-2016	3	Updated Section 4.1: "DPAK (TO-252) type A2 package information". Minor text changes.
03-Jun-2016	4	Updated title and features in cover page. Updated <i>Table 5:</i> "On/Off states". Minor text changes.



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